

STW45N60DM2AG

Automotive-grade N-channel 600 V, 0.085 Ω typ., 34 A MDmesh[™] DM2 Power MOSFET in a TO-247 package

Datasheet - production data

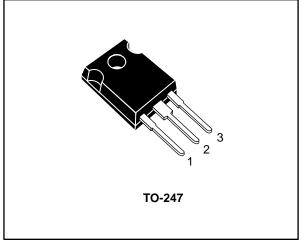
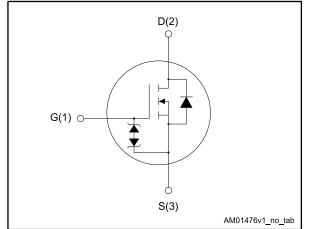


Figure 1: Internal schematic diagram



Features

Order code	V _{DS} @ T _{Jmax.}	R _{DS(on)} max.	ID	Ртот
STW45N60DM2AG	650 V	0.093 Ω	34 A	250 W

- Designed for automotive applications and AEC-Q101 qualified
- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmeshTM DM2 fast recovery diode series. It offers very low recovery charge (Q_{rr}) and time (t_{rr}) combined with low $R_{DS(on)}$, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STW45N60DM2AG	45N60DM2	TO-247	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage ±25		V
1-	Drain current (continuous) at T _{case} = 25 °C		А
ID	Drain current (continuous) at T _{case} = 100 °C	21	A
I _{DM} ⁽¹⁾	Drain current (pulsed)	136 A	
P _{TOT}	Total dissipation at $T_{case} = 25 \text{ °C}$	250 W	
dv/dt ⁽²⁾	Peak diode recovery voltage slope	50	
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature	55 to 150	°C
Tj	Operating junction temperature	-55 to 150	C

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ I_{SD} \leq 34 A, di/dt=800 A/µs; V_{DS} peak < V_{(BR)DSS}, V_{DD} = ~80% V_{(BR)DSS}.

⁽³⁾ $V_{DS} \le 480 \text{ V}.$

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj-case}	Thermal resistance junction-case	0.50	°C/W	
R _{thj-amb}	Thermal resistance junction-ambient	50		

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive	6	А
E _{AS} ⁽¹⁾	Single pulse avalanche energy	800	mJ

Notes:

 $^{(1)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

		Table 5: Static				
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	600			V
	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 600 V$			1	
I _{DSS}		$V_{GS} = 0 V, V_{DS} = 600 V,$ $T_{case} = 125 \text{ °C}$			100	μA
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			±5	μA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}$		0.085	0.093	Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	2500	-	
C _{oss}	Output capacitance	$V_{DS} = 100 V, f = 1 MHz,$	-	120	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	3	-	P
C _{oss eq.} ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 480 V, V_{GS} = 0 V	-	200	-	pF
R_G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 34 A,	-	56	-	
Q _{gs}	Gate-source charge	V_{GS} = 10 V (see <i>Figure 15</i> :	-	13	-	nC
Q _{gd}	Gate-drain charge	"Gate charge test circuit")	-	30	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 25 \text{ A}$	-	29	-	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Switching	-	27	-	
t _{d(off)}	Turn-off delay time	times test circuit for	-	85	-	ns
t _f	Fall time	resistive load" and Figure 19: "Switching time waveform")	-	6	-	

Table 7: Switching times



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Electrical characteristics

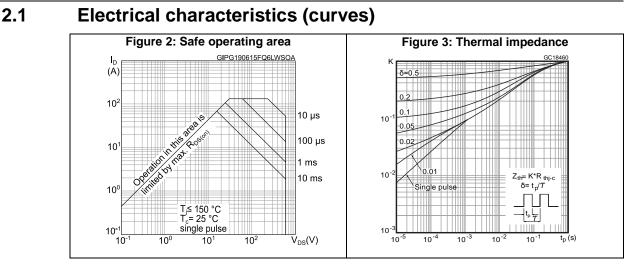
DIVIZAG					anacteri	31103
		Table 8: Source-drain diode			r	
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		34	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		136	А
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 34 A$	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 34 A,	-	120		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/ μ s, V _{DD} = 60 V (see Figure 16: "Test circuit for inductive	-	0.6		μC
I _{RRM}	Reverse recovery current	load switching and diode recovery times")	-	10.4		А
t _{rr}	Reverse recovery time	I _{SD} = 34 A,	-	240		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs, V _{DD} = 60 V, T _j = 150 °C (see <i>Figure 16: "Test</i>	-	2.4		μC
I _{RRM}	Reverse recovery current	circuit for inductive load switching and diode recovery times")	-	20.5		A

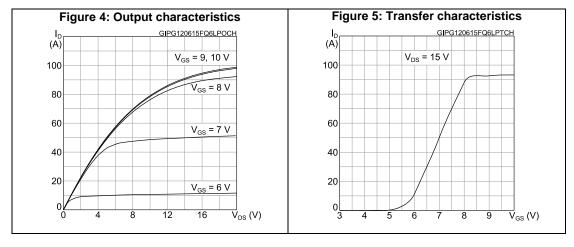
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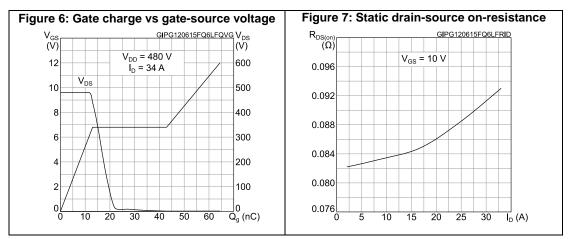
 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

⁽²⁾ Pulse test: pulse duration = 300 μ s, duty cycle 1.5%.



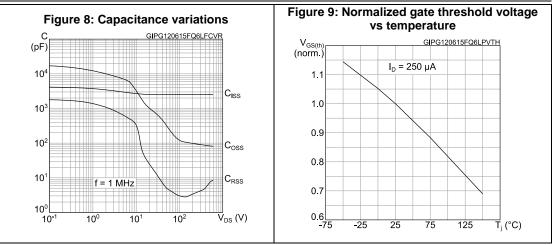


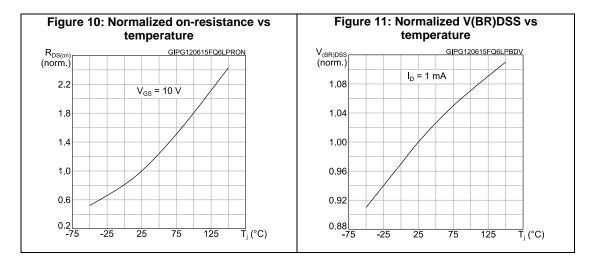


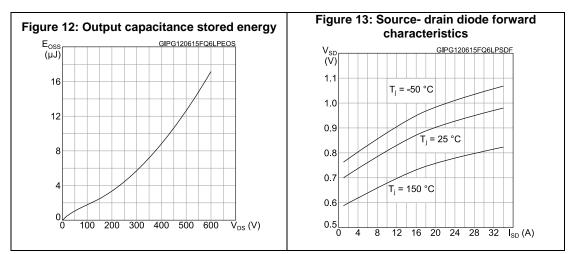




Electrical characteristics



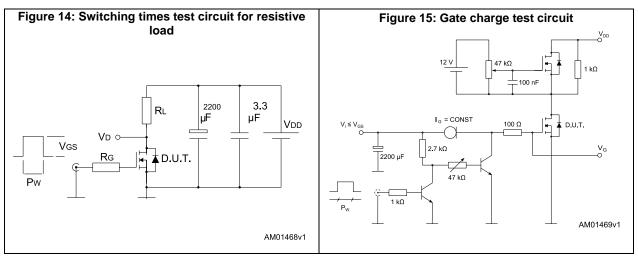


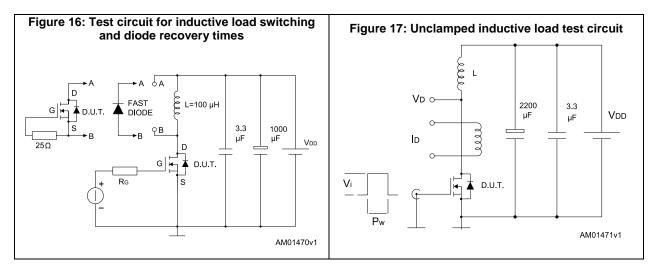


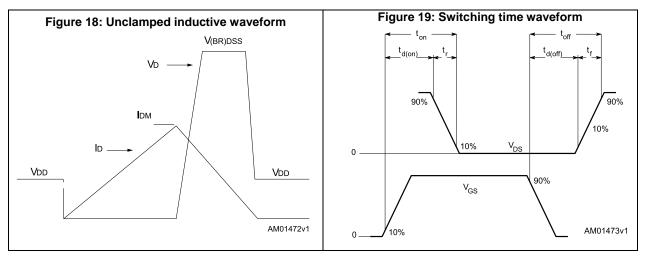
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3 Test circuits







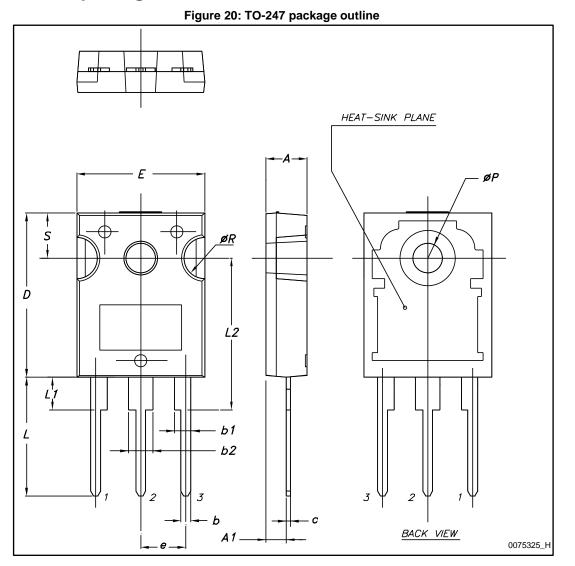
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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information





Package information

STW45N60DM2AG

Table 9: TO-247 package mechanical data				
Dim.	mm.			
	Min.	Тур.	Max.	
A	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е	5.30	5.45	5.60	
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S	5.30	5.50	5.70	

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5 Revision history

Table 10: Document revision history

Date	Revision	Changes
03-Jul-2015	1	Initial release.



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